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# FDS6675

## Single P-Channel, Logic Level, PowerTrench™ MOSFET

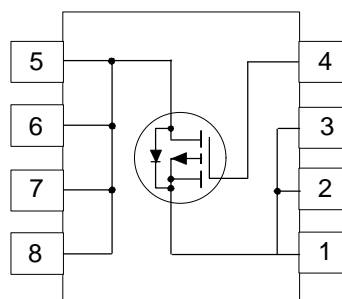
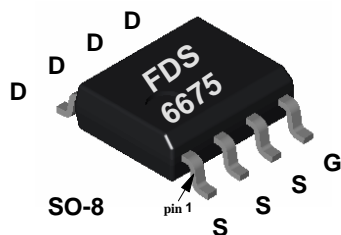
### General Description

This P-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for notebook computer applications: load switching and power management, battery charging circuits, and DC/DC conversion.

### Features

- -11 A, -30 V.  $R_{DS(ON)} = 0.014 \Omega$  @  $V_{GS} = -10$  V,  
 $R_{DS(ON)} = 0.020 \Omega$  @  $V_{GS} = -4.5$  V.
- Low gate charge (30nC typical).
- High performance trench technology for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.



### Absolute Maximum Ratings

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	FDS6675	Units
$V_{DS}$	Drain-Source Voltage	-30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current - Continuous (Note 1a) - Pulsed	-11	A
		-50	
$P_D$	Power Dissipation for Single Operation (Note 1a) (Note 1b) (Note 1c)	2.5	W
		1.2	
		1	
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

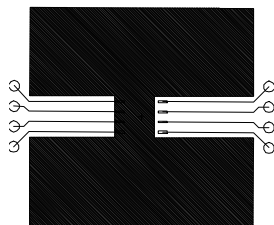
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	50	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	25	$^\circ\text{C/W}$

# Electrical Characteristics (T<sub>A</sub> = 25 °C unless otherwise noted )

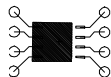
Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-30			V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temp. Coefficient	I <sub>D</sub> = -250 μA, Referenced to 25 °C		-22		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -24 V, V <sub>GS</sub> = 0 V			-1	μA
		T <sub>J</sub> = 55°C			-10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V			-100	nA
ON CHARACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-1	-1.7	-3	V
ΔV <sub>GS(th)</sub> /ΔT <sub>J</sub>	Gate Threshold Voltage Temp. Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25 °C		4.3		mV/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -11 A		0.011	0.014	Ω
		T <sub>J</sub> =125°C		0.016	0.023	
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -9 A		0.015	0.02	
I <sub>D(ON)</sub>	On-State Drain Current	V <sub>GS</sub> = -10 V, V <sub>DS</sub> = -5 V	-50			A
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -11 A		32		S
DYNAMIC CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		3000		pF
C <sub>oss</sub>	Output Capacitance			870		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			360		pF
SWITCHING CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -1 A		12	22	ns
t <sub>r</sub>	Turn - On Rise Time	V <sub>GEN</sub> = -10 V, R <sub>GEN</sub> = 6 Ω		16	27	ns
t <sub>D(off)</sub>	Turn - Off Delay Time			50	80	ns
t <sub>f</sub>	Turn - Off Fall Time			100	140	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -11 A,		30	42	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -5 V		9		nC
Q <sub>gd</sub>	Gate-Drain Charge			11		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				-2.1	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = -2.1 A (Note 2)		-0.72	-1.2	V

Notes:

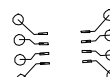
1. R<sub>JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>JA</sub> is guaranteed by design while R<sub>JA</sub> is determined by the user's board design.



a. 50°C/W on a 0.5 in<sup>2</sup> pad of 2oz copper.



b. 105°C/W on a 0.02 in<sup>2</sup> pad of 2oz copper.



c. 125°C/W on a 0.003 in<sup>2</sup> pad of 2oz copper.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%.

## Typical Electrical Characteristics

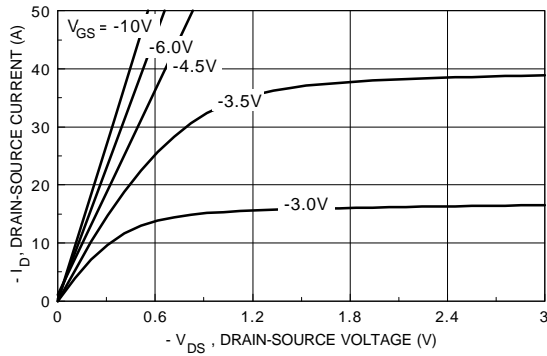


Figure 1. On-Region Characteristics.

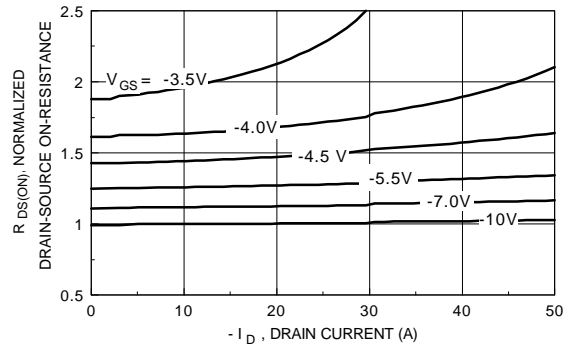


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

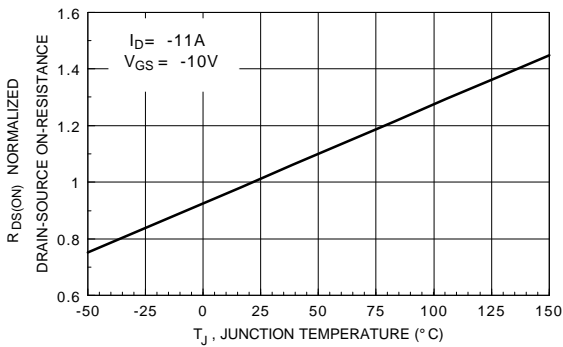


Figure 3. On-Resistance Variation with Temperature.

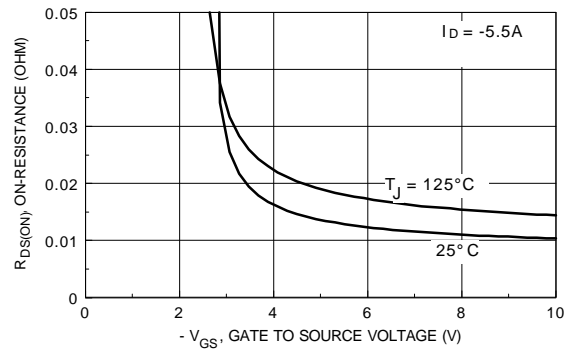


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

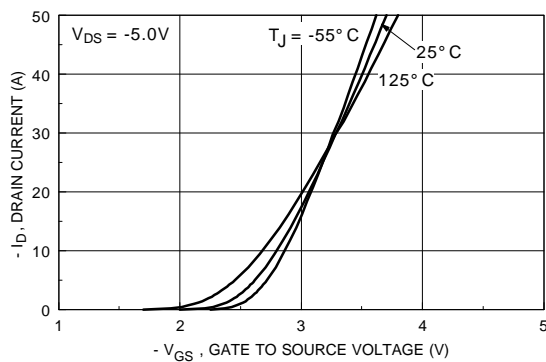


Figure 5. Transfer Characteristics.

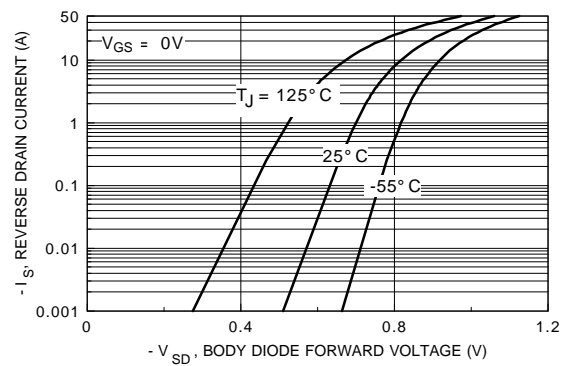


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

## Typical Electrical Characteristics (continued)

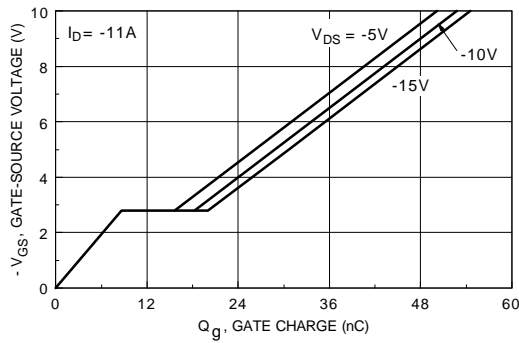


Figure 7. Gate Charge Characteristics.

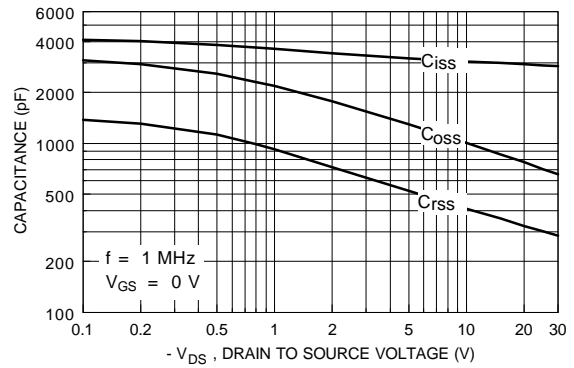


Figure 8. Capacitance Characteristics.

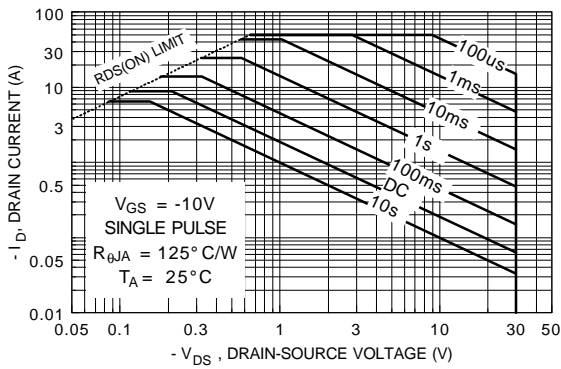


Figure 9. Maximum Safe Operating Area.

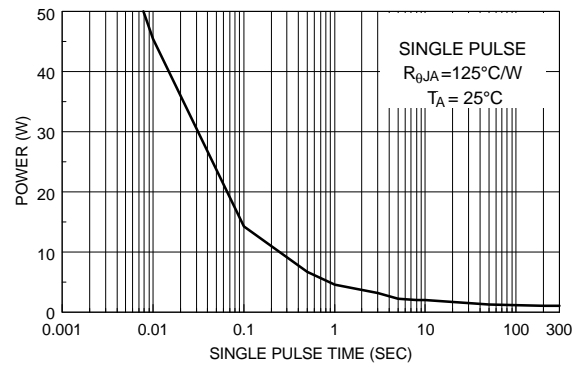


Figure 10. Single Pulse Maximum Power Dissipation.

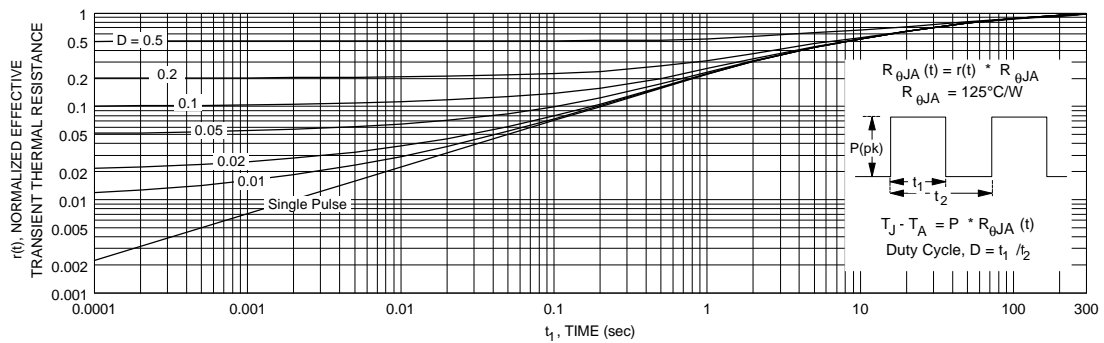


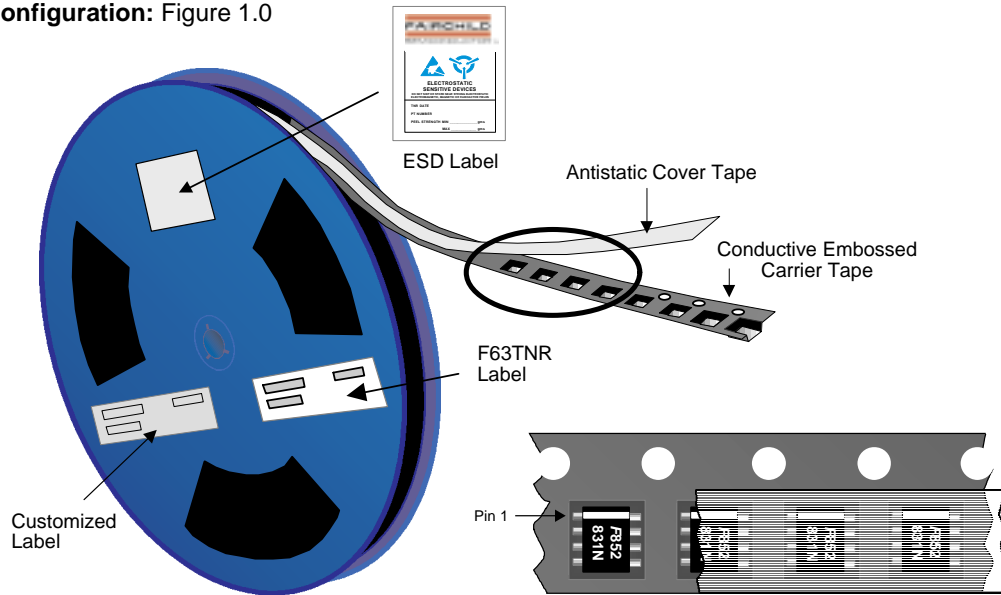
Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c.  
Transient thermal response will change depending on the circuit board design.

# SO-8 Tape and Reel Data and Package Dimensions



## SOIC(8lds) Packaging Configuration: Figure 1.0

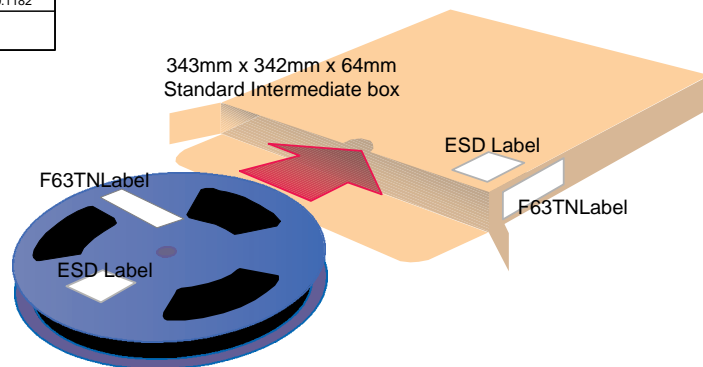


## SOIC-8 Unit Orientation

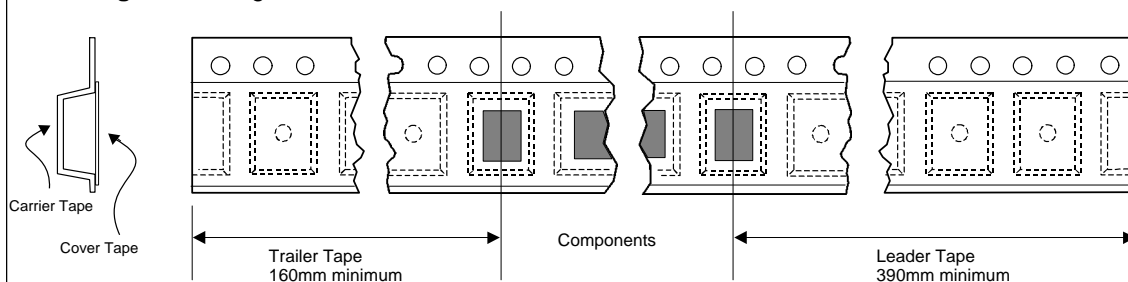
SOIC (8lds) Packaging Information				
Packaging Option	Standard (no flow code)	L86Z	S62Z	D84Z
Packaging type	TNR	Rail/Tube	Bag	TNR
Qty per Reel/Tube/Bag	2,500	95	200	500
Reel Size	13" Dia	-	-	7" Dia
Box Dimension (mm)	343x64x343	530x130x83	76x102x127	184x187x47
Max qty per Box	5,000	30,000	1,000	2,500
Weight per unit (gm)	0.0774	0.0774	0.0774	0.0774
Weight per Reel (kg)	0.6060	-	-	0.1182
Note/Comments			Bulk	

## F63TNR Label sample

LOT: CBVK741B019	QTY: 2500
FSID: FDS9953A	SPEC:
D/C1: D9842	QTY1:
D/C2:	QTY2:
SPEC REV: CPN:	QARV:
	(F63TNR)2



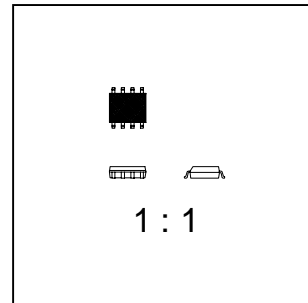
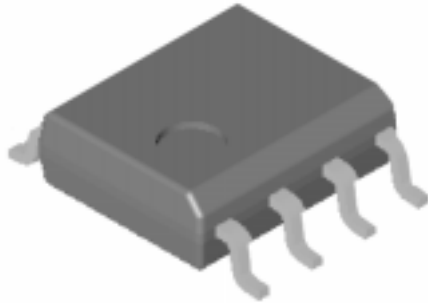
## SOIC(8lds) Tape Leader and Trailer Configuration: Figure 2.0



November 1998, Rev. A

## SO-8 Tape and Reel Data and Package Dimensions, continued

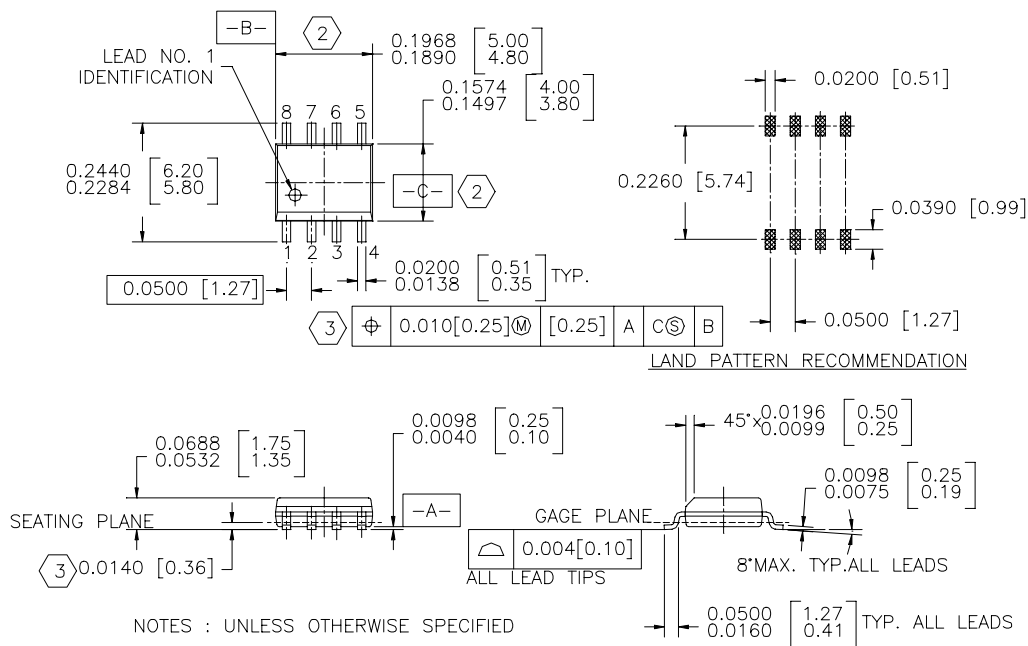
### SOIC-8 (FS PKG Code S1)



Scale 1:1 on letter size paper

Dimensions shown below are in:  
inches [millimeters]

Part Weight per unit (gram): 0.0774





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